

●Features

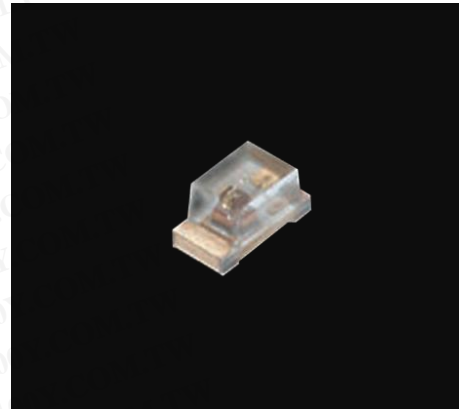
- 1608 standard size(1.6×0.8mm, t=0.8mm)
- Abundant color variations with diverse luminous intensity types

●Size

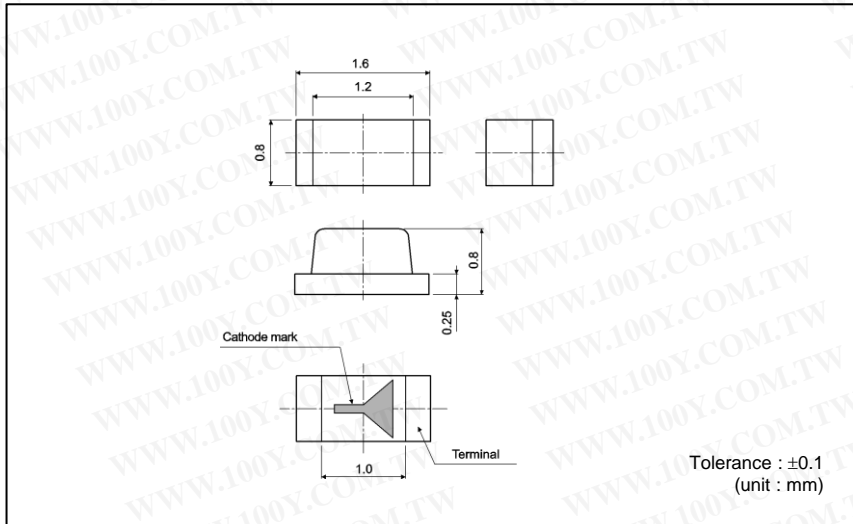
1608(0603)
1.6 × 0.8mm(t=0.8mm)



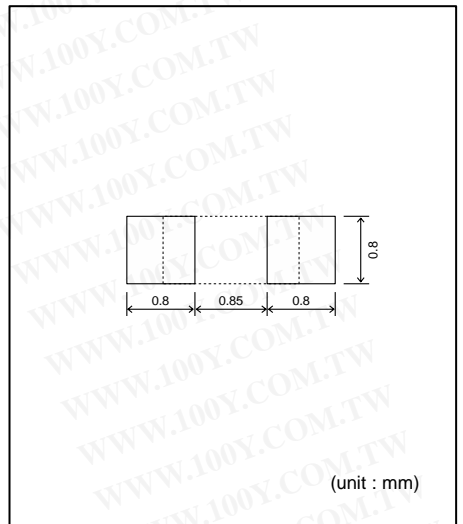
●Outline



●Dimensions



●Recommended Solder Pattern



●Specifications

Part No.	Chip Structure	Emitting Color	Absolute Maximum Ratings (Ta=25°C)					Electrical and Optical Characteristics (Ta=25°C)												
			Power Dissipation P ₀ (mW)	Forward Current I _F (mA)	Peak Forward Current I _{FP} (mA)	Reverse Voltage V _R (V)	Operating Temp. Topr(°C)	Storage Temp. Tstg(°C)	Forward Voltage V _F		Reverse Current I _R		Dominant Wavelength λ _D			Luminous Intensity I _v				
								Typ. (V)	I _F (mA)	Max. (μA)	V _R (V)	Min. (nm)	Typ. (nm)	Max. (nm)	I _F (mA)	Min. (mcd)	Typ. (mcd)	I _F (mA)		
SML-310VT	GaAsP on GaP	Red	55	20	60*1	4	-30 to +85	-40 to +85	2	20	100	4	625	630	635	20	1.4	4	20	
SML-311UT	AlGaInP on GaAs		44						1.8	2			615	620	625	2	0.9	2.5	2	
SML-311DT	AlGaInP on GaAs	Orange	55	20	60*1	4	-30 to +85	-40 to +85	2	20	100	4	602	605	608	20	2.2	6.3	20	
SML-310DT	GaAsP on GaP												55	2	20	587	590	593	2	0.9
SML-311WT	AlGaInP on GaAs	Yellow	44	20	60*1	4	-30 to +85	-40 to +85	1.8	2	100	4	584	587	590	2	2.2	6.3	20	
SML-311YT	GaAsP on GaP												44	2.1	20	567	570	573	2	3.6
SML-310YT	GaAsP on GaP	Yellowish Green	55	20	60*1	4	-30 to +85	-40 to +85	2.2	20	100	4	557	560	563	20	1.4	4	20	
SML-310MT	GaP												55	3.3	20	520	527	535	20	90
SML312ECT	InGaIn	Bluish Green	84	100*2	5	-40 to +100	-40 to +100	3.2	3.2	20	5	5	520	525	535	20	36	90	20	
SML312EC4T													3.2	20	520	525	535	20	36	90
SML312BCT		Blue											3.3	20	464	470	476	22	63	20
SML312BC4T													3.2	20	464	470	476	22	46	20

*1 : Duty1/5, 200Hz *2 : Duty1/10, 1kHz

●Electrical Characteristics Curves

Fig.1 Forward Current - Forward Voltages

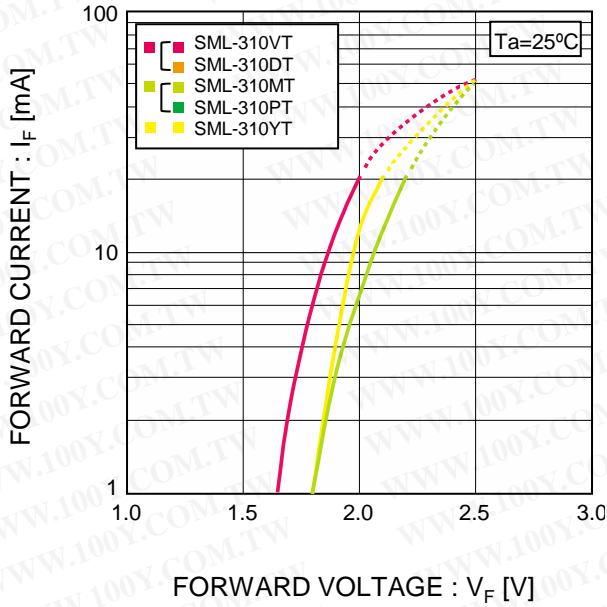


Fig.2 Luminous Intensity - Atmosphere Temperature

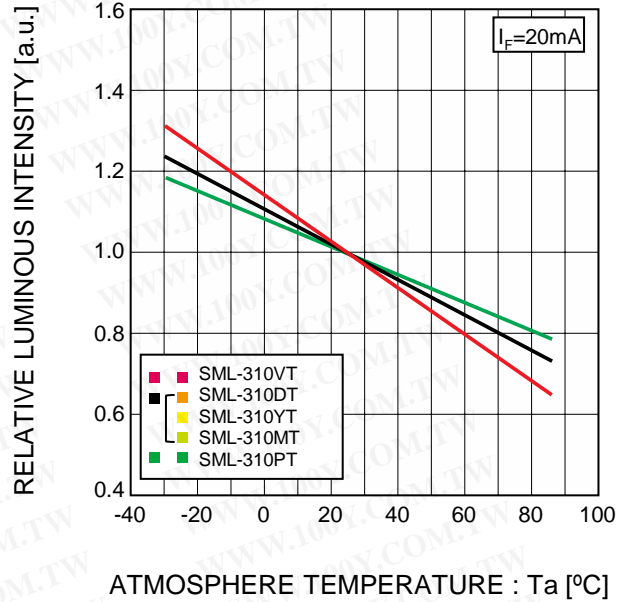


Fig.3 Luminous Intensity - Forward Current

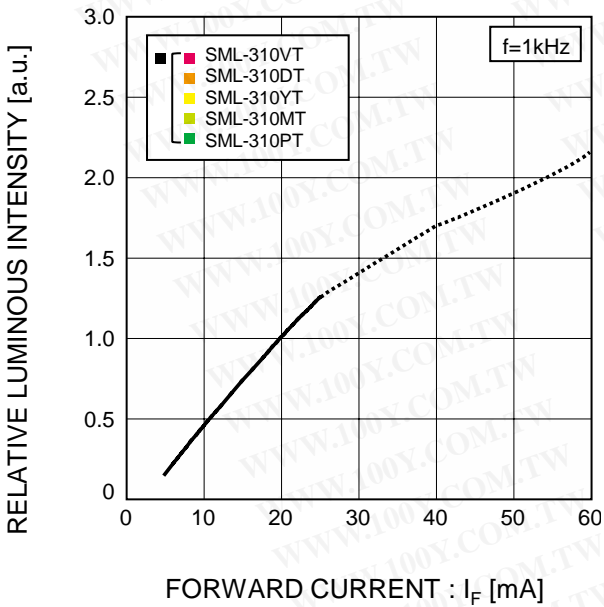
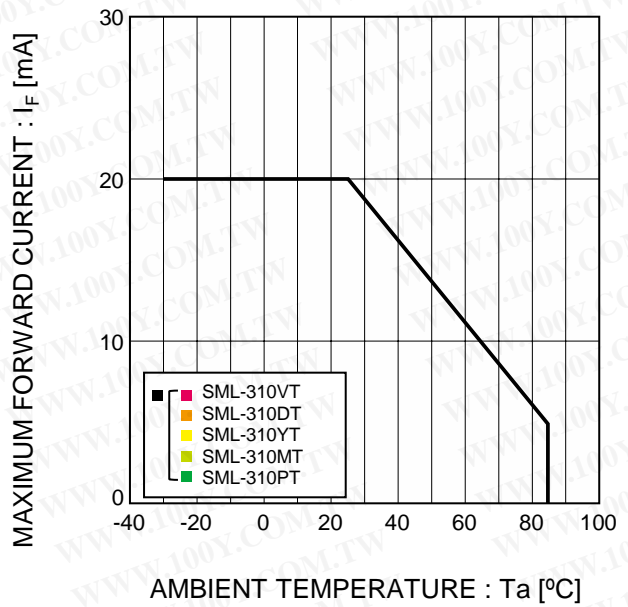


Fig.4 Derating



●Electrical Characteristics Curves

Fig.1 Forward Current - Forward Voltages

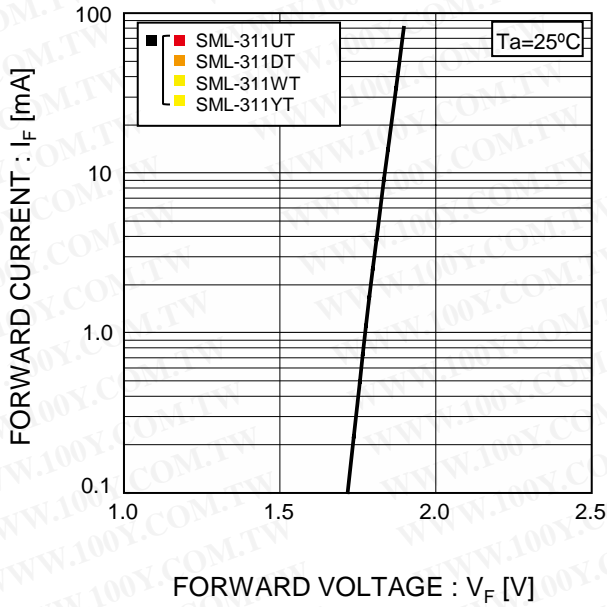


Fig.2 Luminous Intensity - Atmosphere Temperature

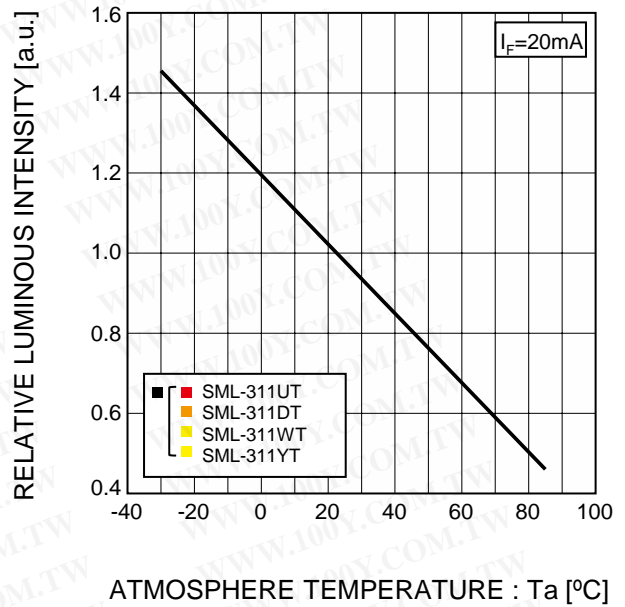


Fig.3 Luminous Intensity - Forward Current

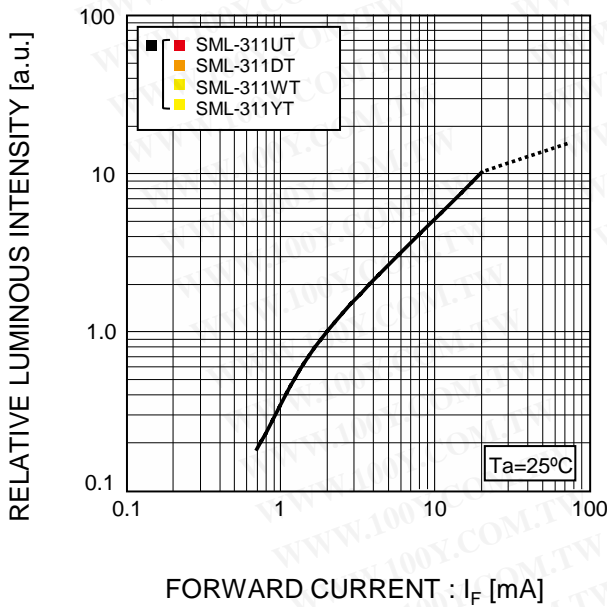
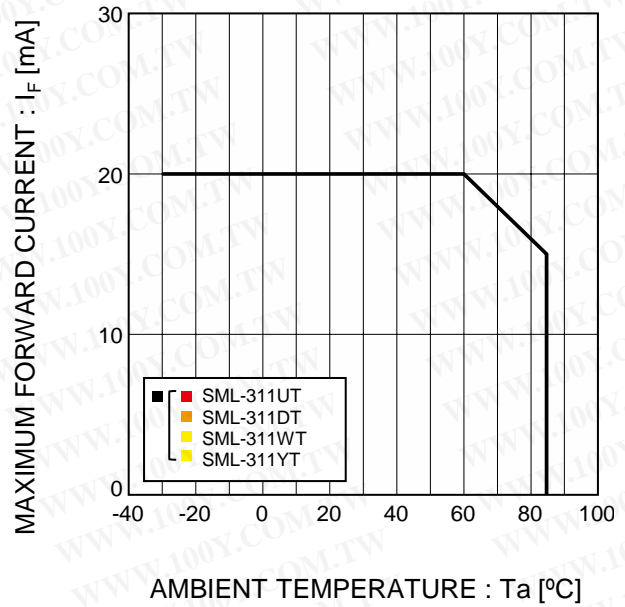


Fig.4 Derating



●Electrical Characteristics Curves

Fig.1 Forward Current - Forward Voltages

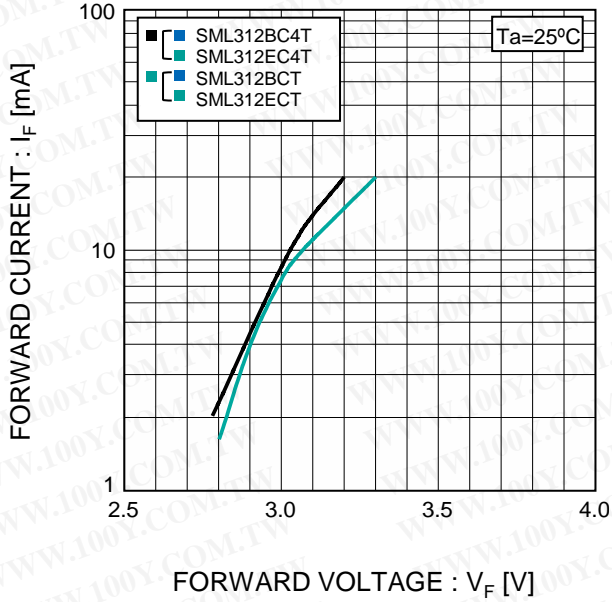


Fig.2 Luminous Intensity - Atmosphere Temperature

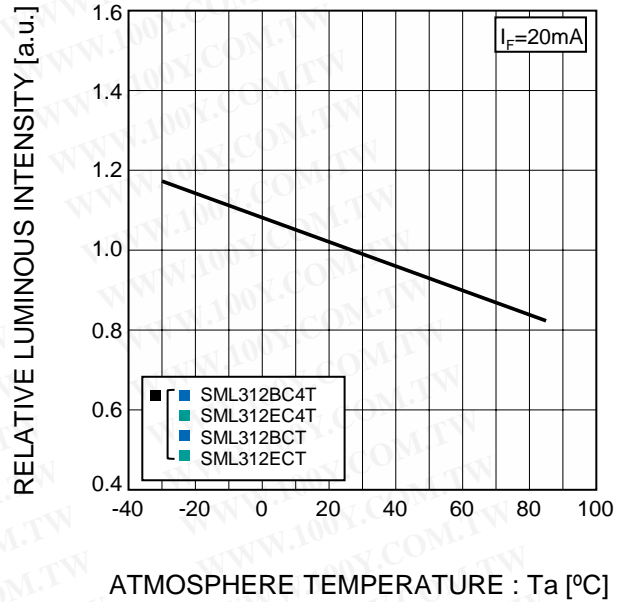


Fig.3 Luminous Intensity - Forward Current

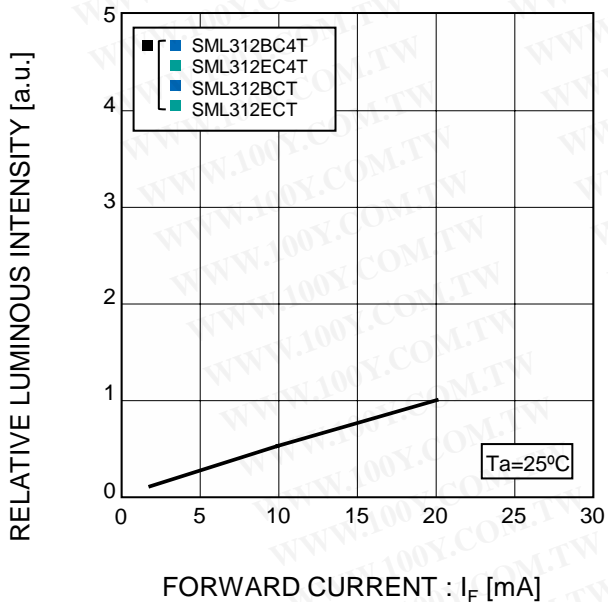
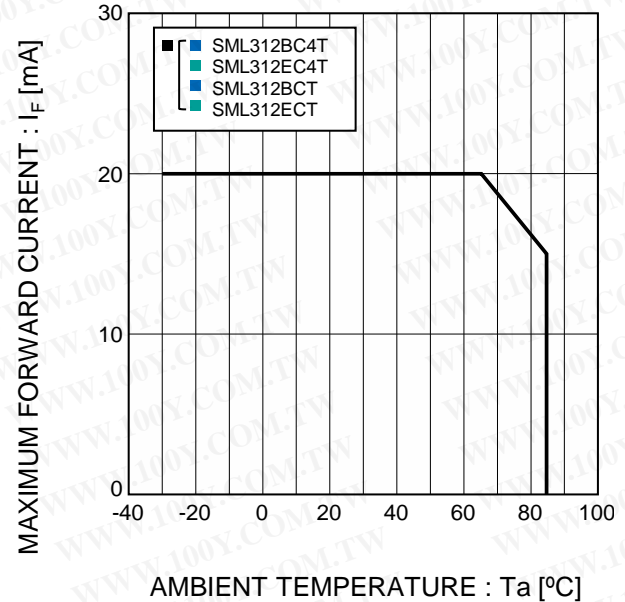
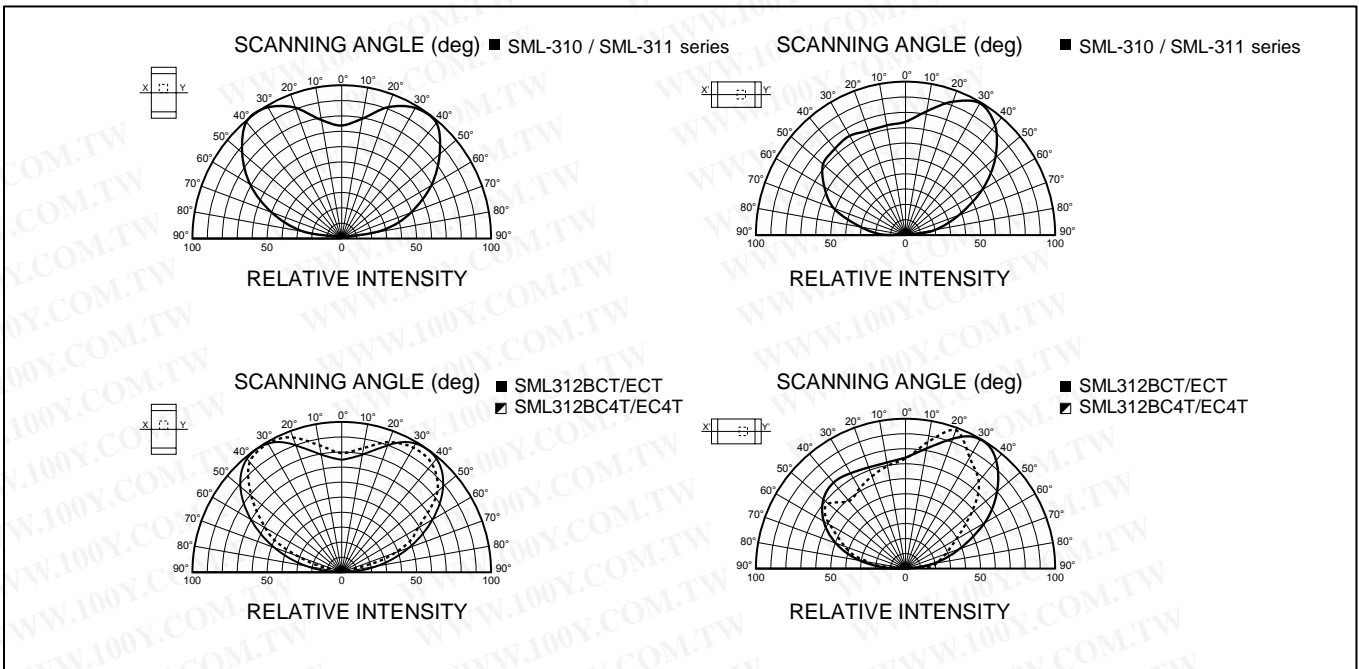


Fig.4 Derating



●Viewing Angle



●Rank Reference of Brightness

Red(V,U)

(Ta=25°C, If=20mA, *1: If=2mA)

Rank	G	H	J	K	L	M	N	P	Q	R	S	T	U	V	W	X
Iv (mcd)	1.0 to 1.6	1.6 to 2.5	2.5 to 4.0	4.0 to 6.3	6.3 to 10	10 to 16	16 to 25	25 to 40	40 to 63	63 to 100	100 to 160	160 to 250	250 to 400	400 to 630	630 to 1000	1000 to 1600
SML-311UT*/*1																
SML-310VT*																

Orange(D)

(Ta=25°C, If=20mA)

Rank	G	H	J	K	L	M	N	P	Q	R	S	T	U	V	W	X
Iv (mcd)	1.0 to 1.6	1.6 to 2.5	2.5 to 4.0	4.0 to 6.3	6.3 to 10	10 to 16	16 to 25	25 to 40	40 to 63	63 to 100	100 to 160	160 to 250	250 to 400	400 to 630	630 to 1000	1000 to 1600
SML-311DT																

Yellow(Y,W)

(Ta=25°C, If=20mA, *1: If=2mA)

Rank	G	H	J	K	L	M	N	P	Q	R	S	T	U	V	W	X
Iv (mcd)	1.0 to 1.6	1.6 to 2.5	2.5 to 4.0	4.0 to 6.3	6.3 to 10	10 to 16	16 to 25	25 to 40	40 to 63	63 to 100	100 to 160	160 to 250	250 to 400	400 to 630	630 to 1000	1000 to 1600
SML-311YT*/*1																
SML-311WT*/*1																
SML-310YT*																

Green (M, P, E)

(Ta=25°C, If=20mA)

Rank	G	H	J	K	L	M	N	P	Q	R	S	T	U	V	W	X
Iv (mcd)	1.0 to 1.6	1.6 to 2.5	2.5 to 4.0	4.0 to 6.3	6.3 to 10	10 to 16	16 to 25	25 to 40	40 to 63	63 to 100	100 to 160	160 to 250	250 to 400	400 to 630	630 to 1000	1000 to 1600
SML-310MT*																
SML-310PT*																
SML-312ECT*																
SML-312EC4T*																

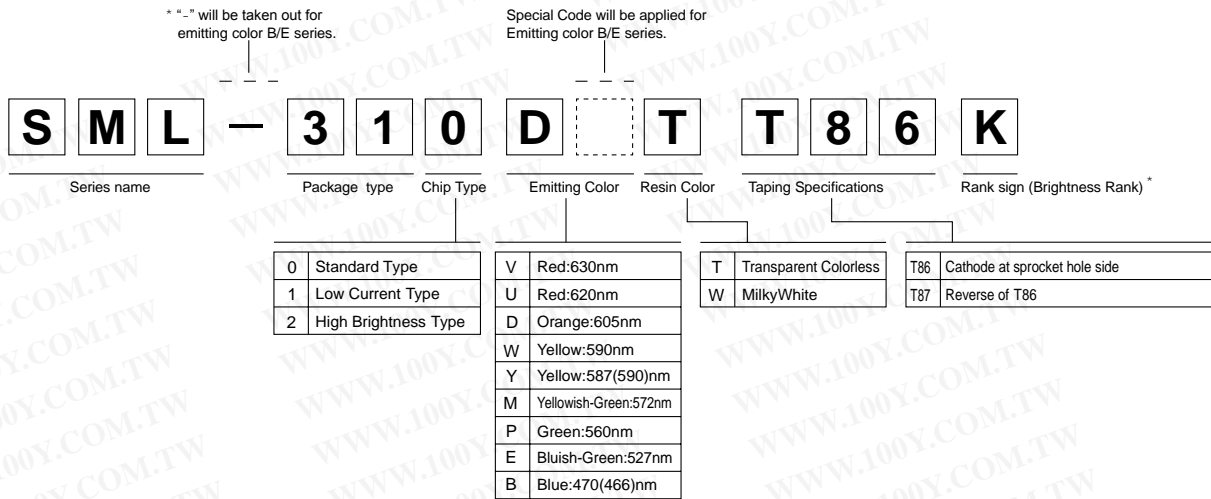
Blue (B)

(Ta=25°C, If=20mA)

Rank	G	H	J	K	L	M	N	P	Q	R	S	T	U	V	W
Iv (mcd)	1.0 to 1.6	1.6 to 2.5	2.5 to 4.0	4.0 to 6.3	6.3 to 10	10 to 16	16 to 25	25 to 40	40 to 63	63 to 100	100 to 160	160 to 250	250 to 400	400 to 630	630 to 1000
SML-312BC4T*															
SML-312BCT*															

* : Brightness on specification sheet include tolerance of w within ±10%.

●Part No. Construction



- * Concerning the Brightness rank
- Please refer to the rank chart above for luminous intensity classification.
- Part name is individual for each rank.
- When shipped as sample, the part name will be a representative part name.
- General products are free of ranks. Please contact sales if rank appointment is needed.

●Packing Specification

ROHM LED products are being shipped with desiccant (silica gel) concluded in moisture-proof bags.

Pasting the moisture sensitive label on the outer surface of the moisture-proof bags or enclosing the humidity indication card inside the bag is available upon request.

Please contact the nearest sales office or distributor if necessary.

●Precaution (Surface Mount Device)

1.Storage

If the product is heated during the reflow under the condition of hygroscopic state, it may vaporize and expand which will influence the performance of the product. Therefore, the package is waterproof. Please use the product following the conditions:

• Using Conditions

Classification	Temperature	Humidity	Expiration Date	Remark
①Before using	5 to 30°C	30 to 70%RH	Within 1 year from Receiving	Storage with waterproof package
②After opening package	5 to 30°C	Below 70%RH	Within168h	Please storing in the airtight container with our desiccant (silica gel)

• Baking

Bake the product in case of below:

- ①The expiration date is passed.
- ②The color of indicator (silica gel) turned from blue to colorless or from green to pink.

(Even if the product is within the expiration date.)

• Baking Conditions

Temperature	Time	Humidity
60±3°C	12 to 24h	Below 20%RH
Remark	<ul style="list-style-type: none"> • Bake products in reel. • Reel and embossed tape are easy to be deformed when baking, so please try not to apply stress on it. • Recommend bake once. 	

2.Application Methods

2-1. Precaution for Drive System and Off Mode

Design the circuit without the electric load exceeding the ABSOLUTE MAXIMUM RATING that applies on the products. If drive by constant voltage, it may cause current deviation of the LED and result in deviation of luminous intensity, so we recommend to drive by constant current. (Deviation of VF Value will cause deviation of current in LED.) Furthermore, for off mode, please do not apply voltage neither forward nor reverse. Especially, for the products with the Ag-paste used in the die bonding, there's high possibility to cause electro migration and result in function failure.

2-2. Operation Life Span

There's possibility for intensity of light drop according to working conditions and environments (applied current, surrounding temperature and humidity, corrosive gases), please call our Sales staffs for inquiries about the concerned application below.

- ①Longtime intensity of light life
- ②On mode all the time

2-3.Applied Stress on Product

The top of the LED is very soft, which the silicon resin is used as sealing resin. Therefore, please pay attention to the overstress on it which may influence its reliability.

2-4.Usage

The Product is LED. We are not responsible for the usage as the diode such as Protection Chip, Rectifier, Switching and so on.

3. Others

3-1. Surrounding Gas

Notice that if it is stored under the condition of acid gas (chlorine gas, sulfured gas) or alkali gas (ammonia), it may result in low soldering ability (caused by the change in quality of the plating surface) or optical characteristics changes (light intensity, chrominance) and change in quality of die bonding (Ag-paste) materials. All of the above will cause function failure of the products.

Therefore, please pay attention to the storage environment for mounted product (concern the generated gas of the surrounding parts of the products and the atmospheric environment).

3-2. Electrostatic Damage

The product is part of semiconductor and electrostatic sensitive, there's high possibility to be damaged by the electrostatic discharge. Please take appropriate measures to avoid the static electricity from human body and earthing of production equipment. The resistance values of electrostatic discharge (actual values) vary with products, therefore, please call our Sales staffs for inquiries.

3-3. Electromagnetic Wave

Please concern the influence on LED in case of application with strong electromagnetic wave such as IH (Induction heating).

4. Mounting

4-1. Soldering

- No resin hardening agent such as filler is used in the sealing resin of the product. Therefore, resin expansion and moisture absorption at humidity will cause heat stress during soldering process and finally has bad influence on the product's reliability.
- The product is not for flow soldering.
- Do not expose the product in the environment of high temperature (over 100°C) or rapid temperature shift (within 3°C of temperature gradient) during the flow soldering of surrounding parts.
- Please set appropriate reflow temperature based on our product usage conditions and specification.
- The max for reflowing is 2 times, please finish the second flow soldering and flow soldering with other parts within the usage limitation after open the moistureproof package.
- Compare with N2 reflow, during air reflow, because of the heat and surrounding conditions, it may cause the discoloration of the resin.
- For our product that has no solder resist, because of its solder amount and soldering conditions, one of its specific characteristics is that solder will penetrate into LED. Thus, there's high possibility that will influence its reliability. Therefore, please be informed, concerning it before using it.

4-2. Automatic Mounting

4-2-1. Silicon Resin Sealing Product

The sealing resin of LED is very soft, so please select adsorption nozzle that would not apply stress directly on the sealing section.

4-2-2. Mini Package (Smaller than 1608 size)

Vibration may result in low mounting rate since it will cause the static electricity of product and adhere to top cover tape. We recommend to

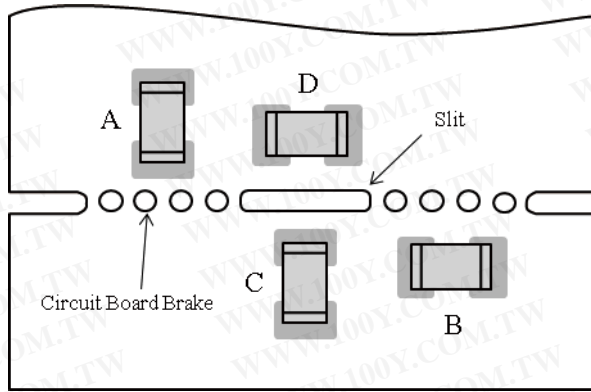
- set magnet on parts feeder cassette of the mounter to control the product stabilization
- set ionizer to prevent electrostatic charge

4-3. Mounting Location

The stress like bending stress of circuit board dividing after mounting, may cause LED package crack or damage of LED internal junction, therefore, please concern the mounting direction and position to avoid bending or screwing with great stress of the circuit board.

4-4. Mechanical Stress after Mounting

The mechanical stress may damage the LED after Circuit Mounting, so please pay attention to the touch on product.

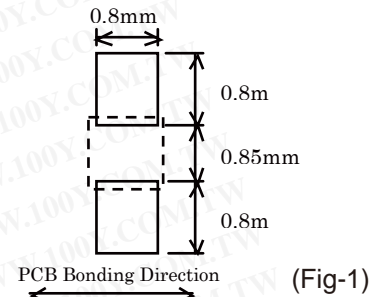


Stress strength according to the mounting position:
A>B>C>D

4-5. Soldering Pattern for Recommendation

We recommend the soldering pattern that shows on the right. It will be different according to mounting situation of circuit board, therefore, please concern before designing.

*The product has adopted the electrode structure that it should solder with back electrode of the product.

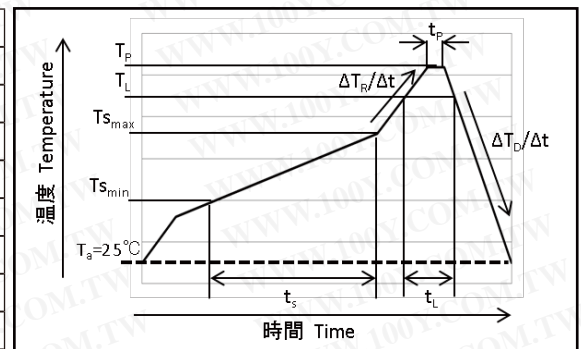


4-6. Reflow Profile

For reflow profile, please refer to the conditions below:(*)

• Meaning of marks, Conditions

Mark	Meanings	Conditions
$T_{s_{max}}$	Maximum of pre-heating temperature	180°C
$T_{s_{min}}$	Minimum of pre-heating temperature	140°C
T_s	Time from $T_{s_{min}}$ to $T_{s_{max}}$	Over 60sec.
T_L	Reference temperature	230 to 260°C
t_L	Retention time for T_L	Within 40sec.
T_P	Peak temperature	260°C(Max)
t_p	Time for peak temperature	Within 10sec.
$\Delta T_R/\Delta t$	Temperature rising rate	Under 3°C/sec.
$\Delta T_D/\Delta t$	Temperature decreasing rate	Over -3°C/sec.



*Above conditions are for reference. Therefore, evaluate by customer's own circuit boards and reflow furnaces before using, because stress from circuit boards and temperature variations of reflow furnaces vary by customer's own conditions.

4-7. Cleaning after Soldering

Please follow the conditions below if the cleaning is necessary after soldering.

Solvent	We recommend to use alcohols solvent such as, isopropyl alcohols
Temperature	Under 30°C within 3 minutes
Ultrasonic Cleaning	15W / Below 1 liter (capacity of tank)
Drying	Under 100°C within 3 minutes

勝特力材料 886-3-5753170
 勝特力电子(上海) 86-21-34970699
 勝特力电子(深圳) 86-755-83298787
[Http://www.100y.com.tw](http://www.100y.com.tw)